

**PATENT ASSIGNMENT**

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Tomoyuki Satoh	03/12/2010
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Kyocera Elco Corporation
<b>Street Address:</b>	1-1, Kagahara 2-chome, Yokohama-shi
<b>City:</b>	Kanagawa
<b>State/Country:</b>	JAPAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12755734
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<b>Total Attachments: 1</b> source=4472-0022Assignment#page1.tif	

**CH \$40.00 12755734**

ASSIGNMENT

THIS INSTRUMENT OF ASSIGNMENT WITNESSETH THAT:

WHEREAS, I, **Tomoyuki SATOH**, resident of c/o KYOCERA ELCO Corporation, 1-1, Kagahara 2-chome, Tsuzuki-ku, Yokohama-shi, Kanagawa, Japan, have invented improvements in

**CONNECTOR**

for which I on April 7, 2010 filed an application for United States Letters Patent as Application Serial No. 12/755,734, claiming priority to Japanese Patent Application No.2009-095293 filed on April 9, 2009, and

WHEREAS, KYOCERA ELCO Corporation, having a place of business at 1-1, Kagahara 2-chome, Tsuzuki-ku, Yokohama-shi, Kanagawa, Japan, a Corporation organized and existing under the Laws of Japan, is desirous of acquiring an interest in said invention, said application and the Letters Patent to be issued therefor;

NOW, THEREFORE, to all whom it may concern, be it known that for and in consideration of the sum of ONE DOLLAR to me in hand paid and other good and valuable consideration, the receipt whereof is hereby acknowledged, I have sold, assigned and set over, and do hereby sell, assign and set over to said corporation, its successors or assigns, the entire right, title and interest to and in said invention in the United States and in all countries foreign to the United States, said United States application for Letters Patent therefor and all divisionals, continuations, reissues, reexaminations and extensions thereof, and the Letters Patent when issued; and I do hereby authorize and request the Commissioner of Patents and Trademarks to issue the Letters Patent based upon said application(s) to said corporation as the assignees of my entire right, title and interest to and in the same, for the sole use and behoof of said corporation, its successors or assigns.

And I also hereby covenant and agree to sign all proper papers including other applications for patents and assignments thereof in the United States and application for patents and assignments in all foreign countries, and to execute all rightful oaths and to take any other proper action that may in the judgment of the said corporation be necessary for securing thereto full rights to said invention, all of the foregoing to be at the expense of said corporation.

IN TESTIMONY WHEREOF, I have hereunto set my hand this 12<sup>th</sup> day of

March, 2010.

Tomoyuki Satoh  
Tomoyuki SATOH

**PATENT**